

EPMDI

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Electronic Packaging Materials, Desings & Innovation (EPMDI)

[HOME](#) [ABOUT](#) [SERVICES](#) [PRODUCTS](#) [COMPETENCES](#) [CONTACT](#)



EPMDI is the consulting agency specialized in electronic packaging. Starting from the basic unit 'Chip' to a final electronic package involves innovation in materials, designs and processes. With vast experience and predictive tools, we cut short material selection and design time for standard and advanced packages e.g, PQFN, ACP, WLCSP, etc. Read more about our package services by clicking the link: [Packaging Services](#).

Packaging Services

Material selection



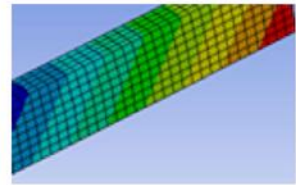
Design selection



Process selection



Finite element modeling



Packaging Materials (Examples)

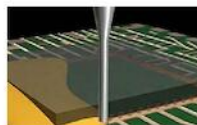
Molding compounds



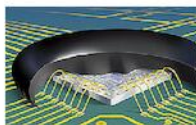
Adhesives/Die-attach



Underfill



Glob top



Substrate



Films

